

Product Summary

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (V) @ +25°C	I _{R(MAX)} (mA) @ +25°C
10	4	0.5	0.2

Description and Applications

The SBRT4U10LP provides very low V_F and excellent reverse leakage stability at high temperatures. It is ideal for use as bypass diode and rectifier, freewheel diode or blocking diode in applications such as:

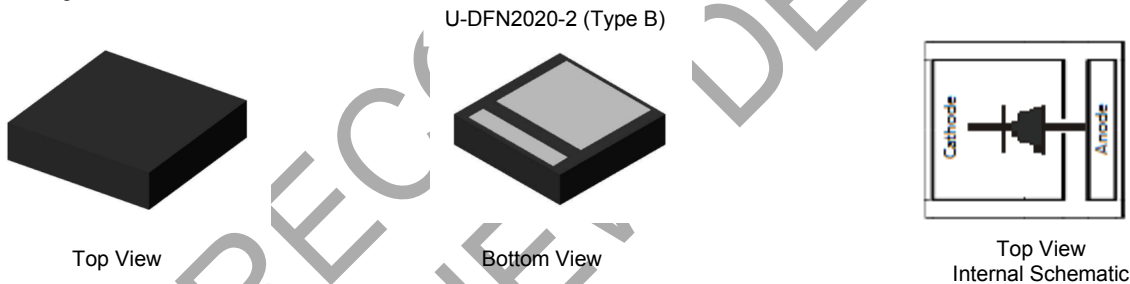
- Solar Panels
- Blocking Diode
- Bypass Diode
- Boost Diode
- Recirculating Diode

Features and Benefits

- Patented TrenchSBR technology provides superior avalanche capability versus Schottky diodes, ensuring more rugged and reliable end applications
- Reduced ultra-low forward voltage drop (V_F).
Better efficiency and cooler operation
- Reduced high temperature reverse leakage.
Increased reliability against thermal runaway failure in high temperature operation
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**
- **Qualified to AEC-Q101 Standards for High Reliability**

Mechanical Data

- Case: U-DFN2020-2 (Type B)
- Case Material: Molded Plastic, "Green" Molding Compound.
UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin Annealed over Copper Leadframe.
Solderable per MIL-STD-202, Method 208 (3)
- Polarity: See Below
- Weight: 6.757mg (Approximate)

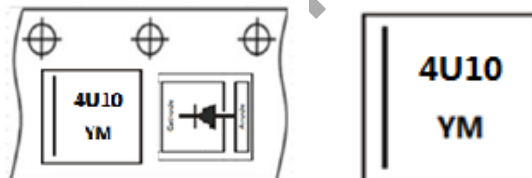


Ordering Information (Note 4)

Part Number	Case	Packaging
SBRT4U10LP-7	U-DFN2020-2 (Type B)	3,000/Tape & Reel

- Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
 4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

Marking Information



4U10 = Product Type Marking Code
 YM = Date Code Marking
 Y = Year (ex: B = 2014)
 M = Month (ex: 6 = June)
 Bar = Cathode

Date Code Key

Year	2014	2015	2016	2017	2018	2019	2020	2021	2022			
Code	B	C	D	E	F	G	H	I	J			
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

Maximum Ratings (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load.
For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V_{RRM}	10	V
Working Peak Reverse Voltage	V_{RWM}		
DC Blocking Voltage	V_{RM}		
Average Rectified Output Current	I_O	4	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I_{FSM}	35	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit	
Typical Thermal Resistance Junction to Case (Note 5)	$R_{\theta JC}$	6	$^\circ\text{C/W}$	
Typical Thermal Resistance Junction to Ambient (Note 5)	$R_{\theta JA}$	65	$^\circ\text{C/W}$	
Operating Temperature Range	T_J	$V_R \leq 80\% V_{RRM}$ $V_R \leq 50\% V_{RRM}$	-55 to +150 $\leq +175$ $\leq +200$	$^\circ\text{C}$
DC Forward Mode (Note 7)				
Storage Temperature Range	T_{STG}	-55 to +150	$^\circ\text{C}$	

Electrical Characteristics (@ $T_A = +25^\circ\text{C}$, unless otherwise specified.)

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Forward Voltage Drop (Note 6)	V_F	—	—	0.500	V	$I_F = 4\text{A}$, $T_J = +25^\circ\text{C}$
Leakage Current (Note 6)	I_R	—	6.5	200	μA mA	$V_R = 10\text{V}$, $T_J = +25^\circ\text{C}$ $V_R = 10\text{V}$, $T_J = +125^\circ\text{C}$

Notes: 5. Device mounted on FR4 PCB pad layout 1inch 2oz copper
6. Short duration pulse test used to minimize self-heating effect.
7. Max junction temperature guaranteed for two hours.

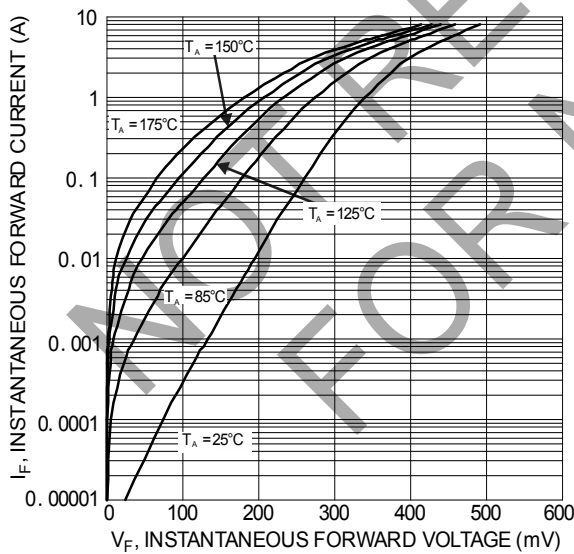


Figure 1 Typical Forward Characteristics

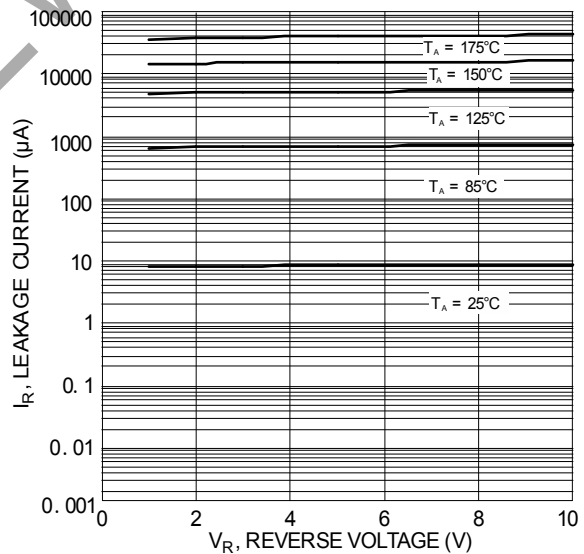
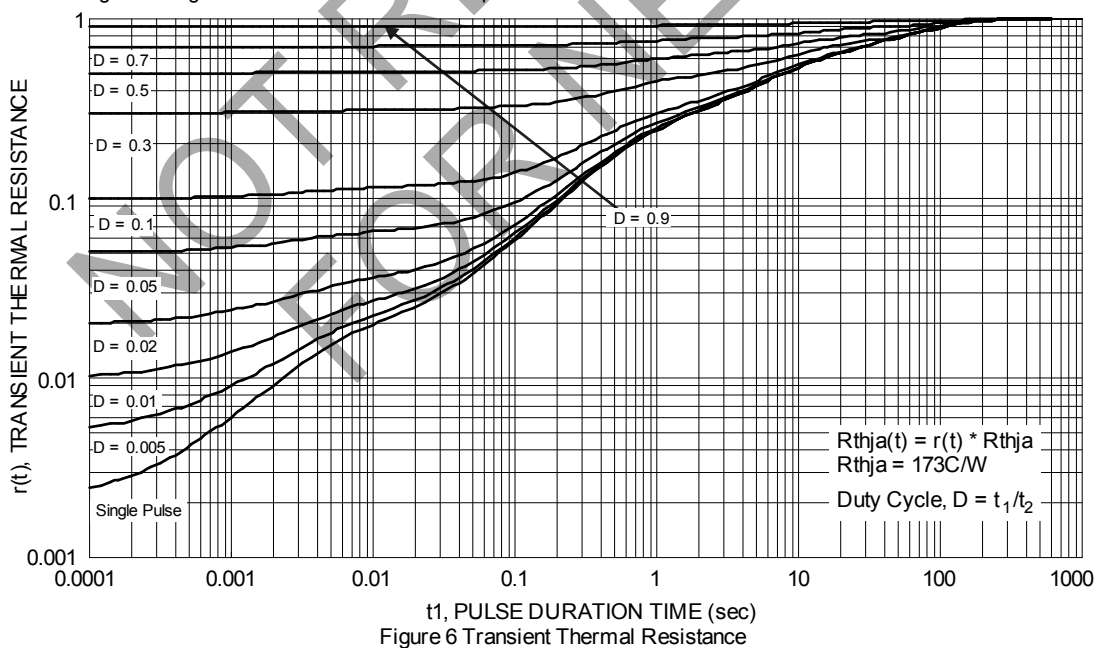
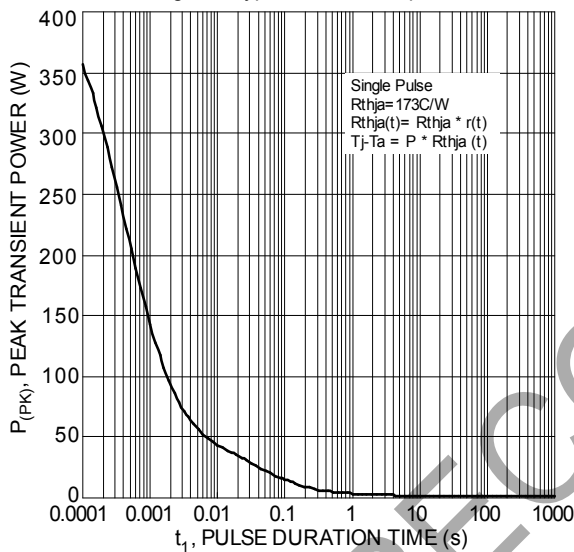
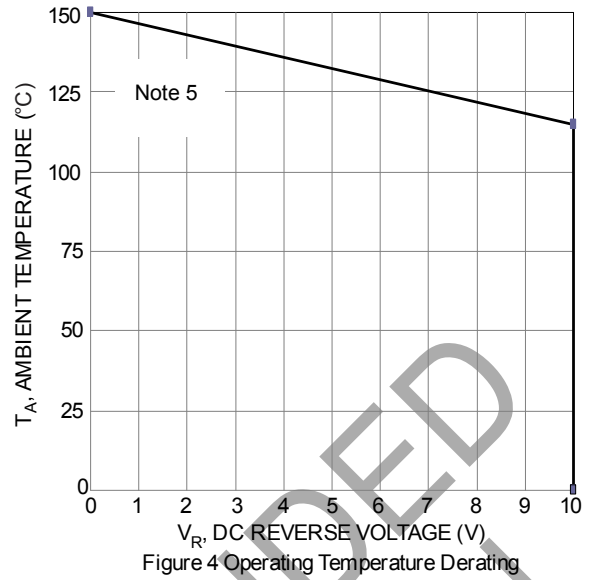
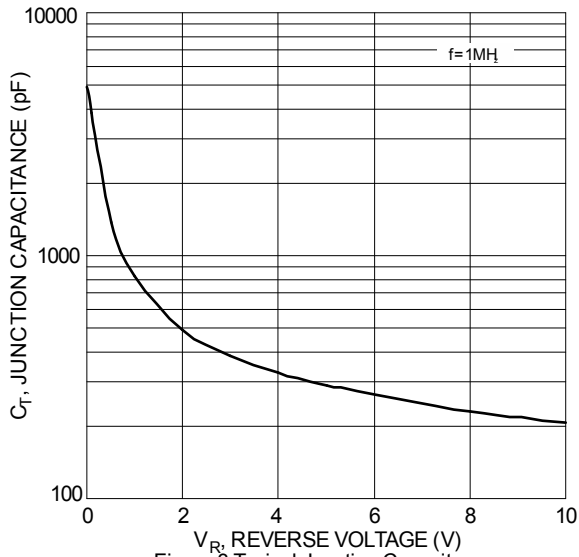
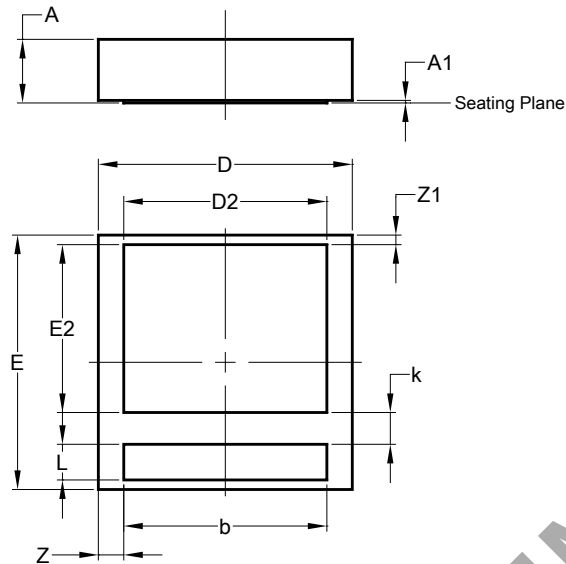


Figure 2 Typical Reverse Characteristics



Package Outline Dimensions

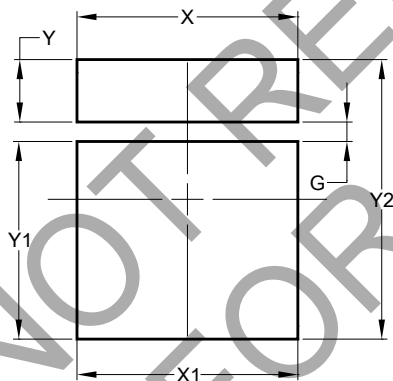
Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for the latest version.



U-DFN2020-2 (Type B)			
Dim	Min	Max	Typ
A	0.47	0.53	0.50
A1	0.00	0.05	0.02
b	1.55	1.65	1.60
D	1.95	2.05	2.00
D2	1.50	1.70	1.60
E	1.95	2.05	2.00
E2	1.22	1.42	1.32
k	0.25 BSC		
L	0.23	0.33	0.28
Z	0.20 BSC		
Z1	0.075 BSC		
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
G	0.150
X	1.700
X1	1.700
Y	0.480
Y1	1.520
Y2	2.150

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